

RoHS Compliant Product  
A suffix of "C" specifies halogen & lead-free

## FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

## MECHANICAL DATA

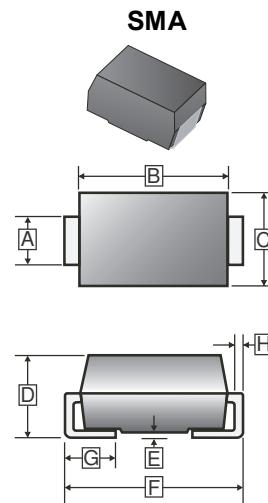
- Terminals: Solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Weight: 60mg (Approx.)

## MARKING

SS24

## PACKAGE INFORMATION

Package	MPQ	Leader Size
SMA	5K	13 inch



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	1.24	1.65	E	-	0.203
B	3.99	4.75	F	4.80	5.28
C	2.40	2.90	G	0.76	1.52
D	1.90	2.44	H	0.15	0.31

## ORDER INFORMATION

Part Number	Type
SM240AR-C	Lead (Pb)-free and Halogen-free

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20%)

Parameter	Symbol	Ratings		Unit
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	40		V
Maximum RMS Voltage	V <sub>RMS</sub>	28		V
Maximum DC Blocking Voltage	V <sub>DC</sub>	40		V
Maximum Average Forward Rectified Current	I <sub>F</sub>	2		A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	50		A
Maximum Instantaneous Forward Voltage @I <sub>F</sub> =2A	V <sub>F</sub>	0.55		V
Maximum DC Reverse Current at Rated DC Reverse Voltage	I <sub>R</sub>	0.5	mA	
T <sub>A</sub> =25°C		5		
T <sub>A</sub> =100°C				
Typical Junction Capacitance <sup>1</sup>	C <sub>J</sub>	220		pF
Typical Thermal Resistance <sup>2</sup>	R <sub>θJA</sub>	80		°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~150		°C

Notes:

1. Measured at 1 MHz and applied reverse voltage of 4 V D.C.
2. P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

## RATINGS AND CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

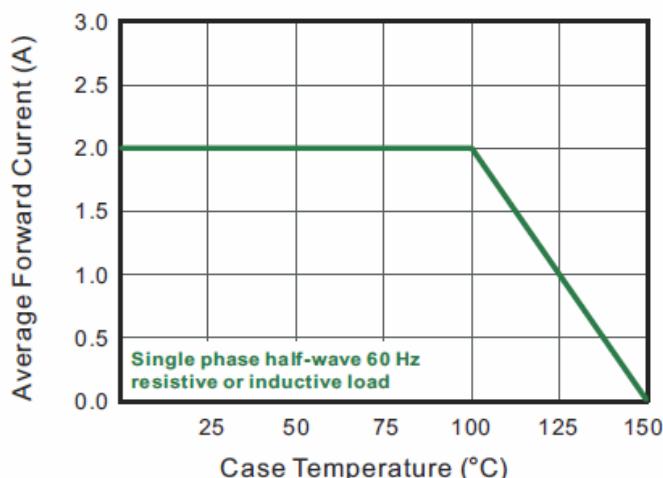


Fig.2 Typical Reverse Characteristics

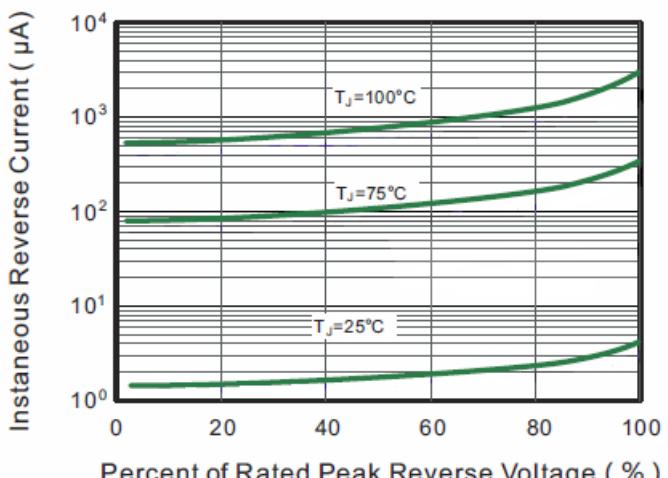


Fig.3 Typical Forward Characteristic

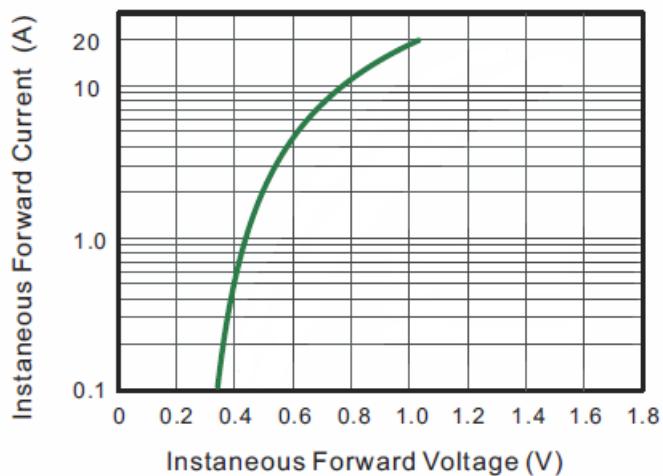


Fig.4 Typical Junction Capacitance

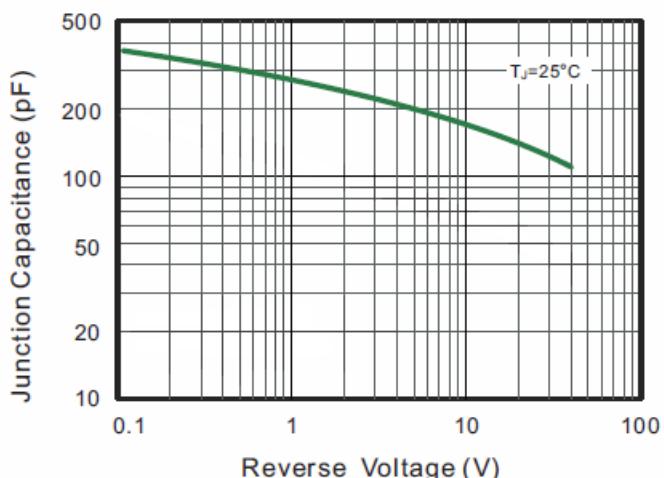


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

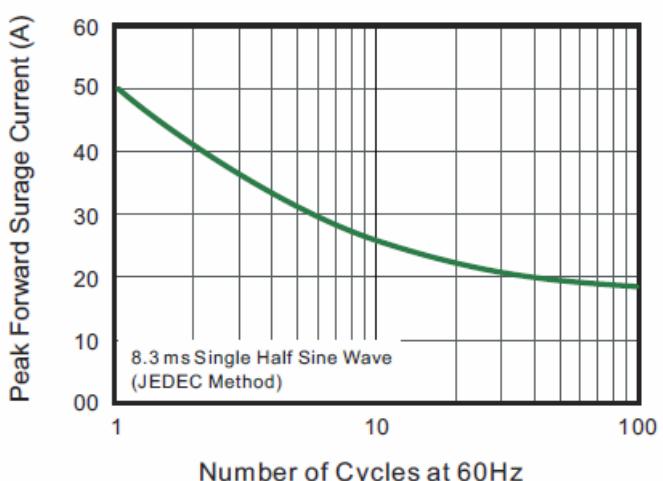


Fig.6- Typical Transient Thermal Impedance

